



SPECIFICATION FOR TFT LCD MODULE

CUSTOMER : _____

CUSTOMER MODULE : _____

HL MODEL : HG040WV006T02

Preliminary Specification

Final Specification

Customer Confirmation column:

Approved by : _____ Dept. : _____ Data : _____

Please return one of the copies of the specification with your signature to us within two weeks after you receive this document. If it is not returned, we will assume that you agree to the entire contents of this specification document.

Designed by	Checked by	Approved by



CONTENTS

No.	ITEM	PAGE
1.	GENERAL INFORMATION	4
2.	DIAGRAM FOR LCM	5
3.	I/O CONNECTION & BLOCK DIAGRAM	6~7
4.	ELECTRICAL CHARACTERISTICS	8~11
5.	ELECTRO-OPTICAL CHARACTERISTICS	12~14
6.	RELIABILITY TEST CONDITIONS	15
7.	INSPECTION STANDARDS	16~17
8.	PACKAGE DRAWING	18



1. GENERAL INFORMATION

1.1 features

- 1) Structure: TFT PANNEL+IC+FPC+BL+CTP
- 2) IPS Type LCD 480 dot-segment and 800 dot-common outputs
- 3) 16.7M Color can be selected by software
- 4) White LED back light
- 5) MIPI-2 interface
- 6) Operation Temperature : -20~70°C
- 7) Storage Temperature : -30~80°C
- 8) CTP cover lens : Asahi
- 9) CTP structure : G+F+F
- 10) LED life time: -/

1.2 General specification

Item of	Contents	Unit
Panel Size	4.0	inch
LCD Type	a-si/TRANSMISSIVE	/
Display mode	Normally Black	/
Pixel arrangement	480*3(RGB)*800	Dots
Pixel pitch (W*H)	0.108 (V) *0.108 (V)	um
Active Area	51.84 (H) *86.4 (V)	Mm
Module area (W*H*T)	57.14 (V) *96.85 (H) *3.4 (T)	Mm
Recommended Viewing Direction	ALL	0' clock
LCM-IC	ILI9806E-2	/
TP-IC	ILI2511	
Interface	2 lane MIPI	/
Luminance for LCM	350	cd/m2
NTSC	70	%
Weight	TBD	g



3. I/O CONNECTION & BLOCK DIAGRAM

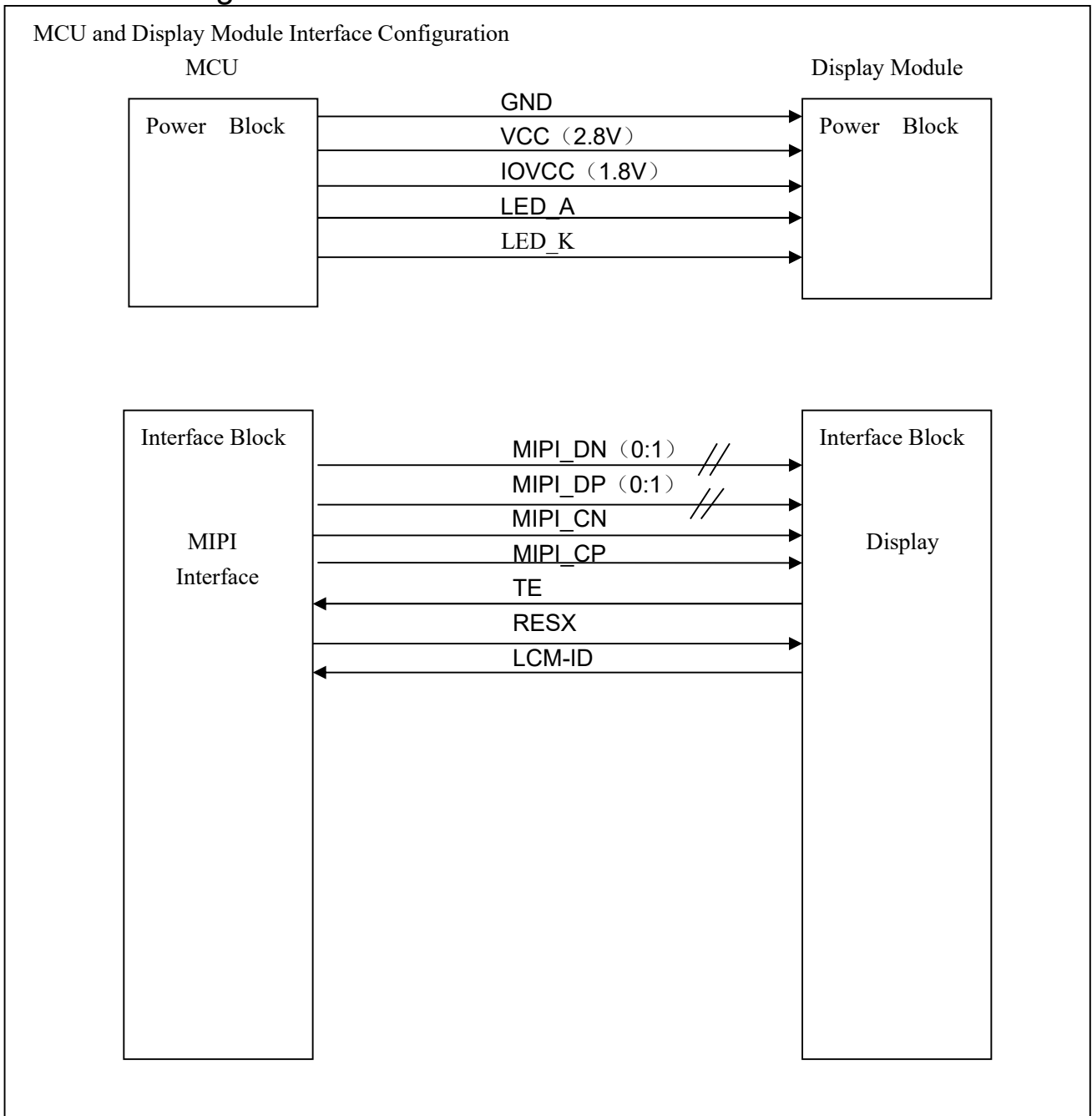
3.1 I/O connection

LCM Pin NO.	Symbol	I/O	Description
1	LCM-ID	O	ID Select
2-4	GND	P	Power Ground
5	RESX	I	No connection / Reset pin
6	IOVCC(1.8V)	P	Power supply for digital circuits and IO pads(1.8V)
7	GND	P	Power Ground
8	MIPI_D0N	I	DSI-D0- differential data signals for MIPI interface
9	NC	-	No connect
10	MIPI_D0P	I	DSI-D0+ differential data signals for MIPI interface
11	GND	P	Power Ground
12	MIPI_CN	I	DSI-CLK- differential clock signals for MIPI interface
13	NC	-	No connect
14	MIPI_CP	I	DSI-CLK+ differential clock signals for MIPI interface
15	GND	P	Power Ground
16	MIPI_D1N	I	DSI-D1- differential data signals for MIPI interface
17	NC	-	No connect
18	MIPI_D1P	I	DSI-D1+ differential data signals for MIPI interface
19	GND	P	Power Ground
20	NC	-	No connect
21	VCC (2.8V)	P	Power supply to the internal logic power regulator(2.8V)
22	TE	O	Tearing effect output pin to synchronize MCU to frame writing
23	LED_K	P	Power supply for LED-
24	LED_A	P	Power supply for LED+
25	GND	P	Power Ground

I: Input; O: Output; P: Power



3.2 block diagram





4. ELECTRICAL CHARACTERISTICS

4.1 Typical Operation Conditions

Item	Symbol	Values			Unit	Remarks
		Min.	Typ.	Max.		
Power Voltage Supply1	VCC(2.8V)	3.0	3.3	3.6	V	-
Power Voltage Supply2	IOVCC(1.8V)	1.65	1.8	3.6	V	
Luminance	Lv	-	350	-	cd/m2	
Backlight Forward Voltage	Vf	-	25.6	-	V	-
LED Forward Current	If	-	20	-	MA	Note

Note: The "LED life time" is defined as the module brightness decrease to 50% of original brightness at $I_L=20\text{mA}$ (for each led). The LED life time could be decreased if operating I_L is larger than 20mA



BACKLIGHT CIRCUIT DIAGRAM 20mA/LED (8LED)
LED Vf: 25.6V (TYP)

背光电路图



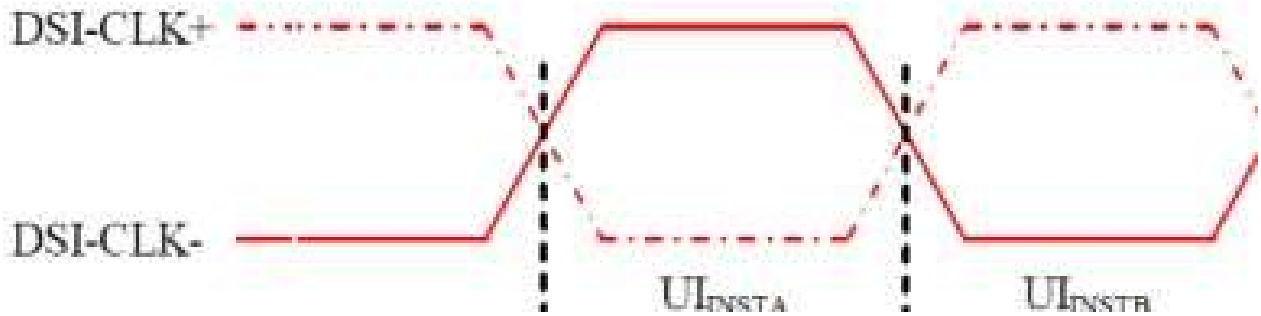
4.2 DC CHARACTERISTICS

Item	Symbol	Condition	Min.
Power & Operation Voltage			
Operating voltage	VCI VCIP VCIR	-	2.5
Operating voltage	IOVCC	-	1.65
OTP Supply voltage	VPP	-	
Logic High level input voltage	V _{IH}	-	0.7*IOVCC
Logic Low level input voltage	V _{IL}	-	-0.3
Logic High level output voltage TE, SDO (SDA) , LEDPWM	V _{OH}	I _{OH} = -1.0mA	0.8*IOVCC
Logic Low level output voltage TE, SDO (SDA) , LEDPWM	V _{OL}	I _{OL} = +1.0mA	0
Gate Driver High Voltage	VGH	-	10.0
Gate Driver Low Voltage	VGL	-	-15.0
Driver Supply Voltage	-	VGH-VGL	16
VCOM Operation			
DC VCOM Amplitude Voltage	VCOM	-	-4.0
Source Driver			
Source Output Range	V _{SOUT}	-	VREG2OUT +0.1
Positive Gamma Reference Voltage	VREG1OUT	-	3.0
Negative Gamma Reference Voltage	VREG2OUT	-	-6.1875
Source Output Setting Time	T _r	Below with 99% precision	-
Output Deviation Voltage (Source Output channel)	V _{dev}	S _{out} >=4.2V S _{out} <=0.8V	-



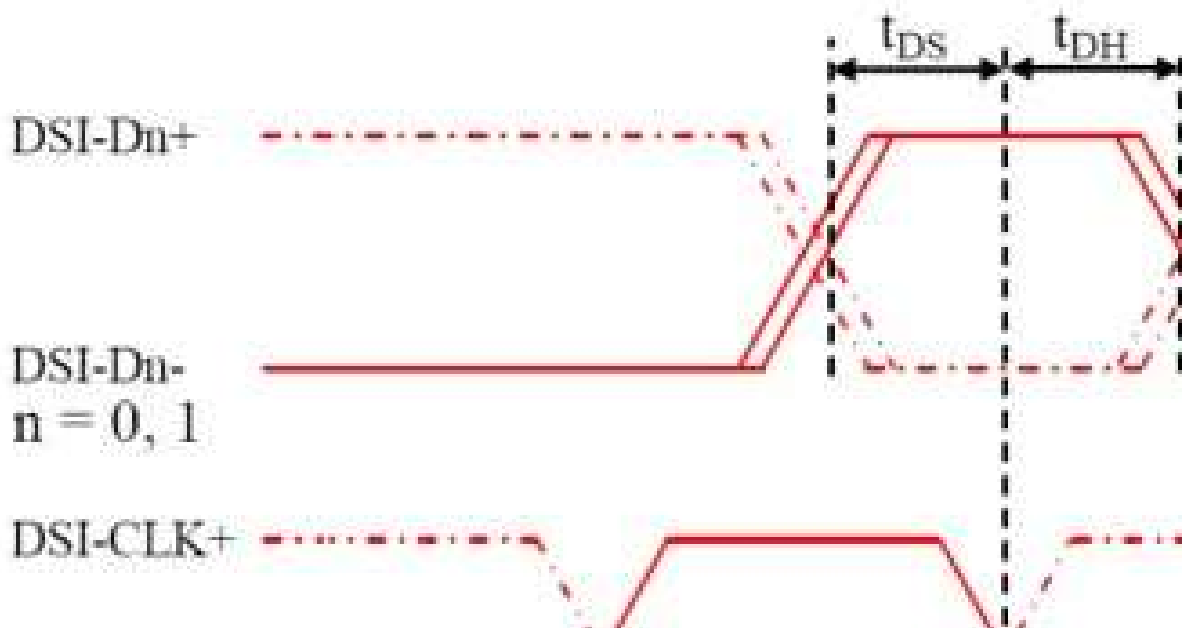
4.3 AC Characteristics

4.3.1 High Speed Mode – Clock Channel Timing



Signal	Symbol	Parameter
DSI-CLK+/-	$2 \times UI_{INST}$	Double UI instantaneous
DSI-CLK+/-	UI_{INSTA}, UI_{INSTB}	UI instantaneous H

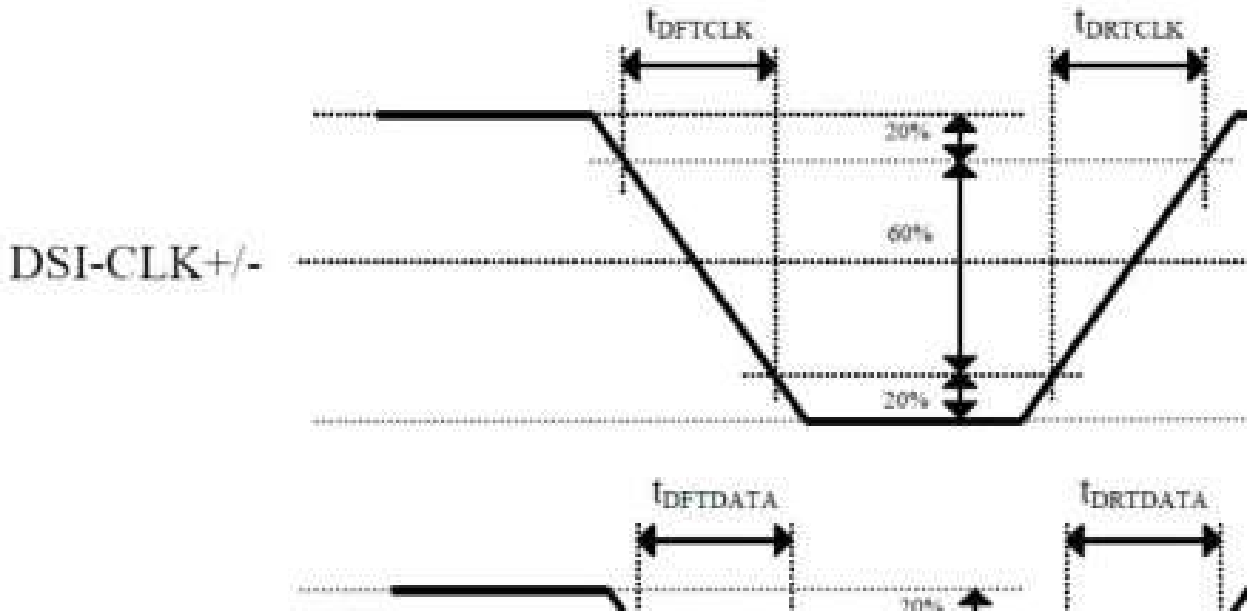
4.3.2 High Speed Mode – Data Clock Channel Timing



Signal	Symbol	Parameter
DSI-Dn+/- n=0 and 1	t_{DS}	Data to Clock Setu

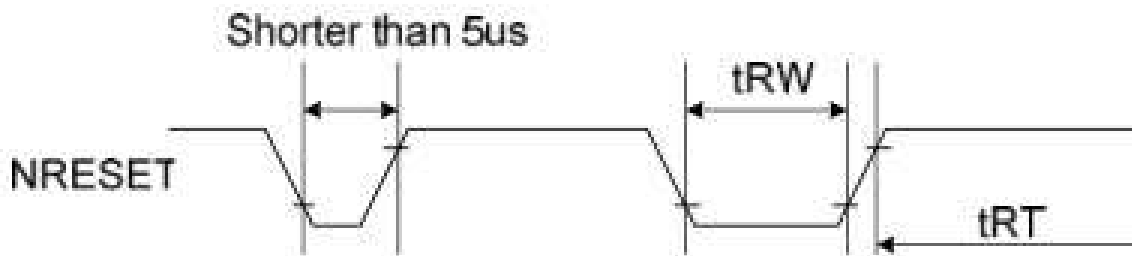


4.3.3 High Speed Mode – Rise and Fall Timings



Parameter	Symbol	Condition
Differential Rise Time for Clock	t_{DRTCLK}	DSI-CLK+/-
Differential Rise Time for Data	$t_{DRTDATA}$	DSI-Dn+/- n=0 and 1

4.4 Reset Timing



Signal	Symbol	Parameter	Min
RESX	t_{RW}	Reset pulse duration	10
	t_{RT}	Reset recover	



5. ELECTRO-OPTICAL CHARACTERISTICS

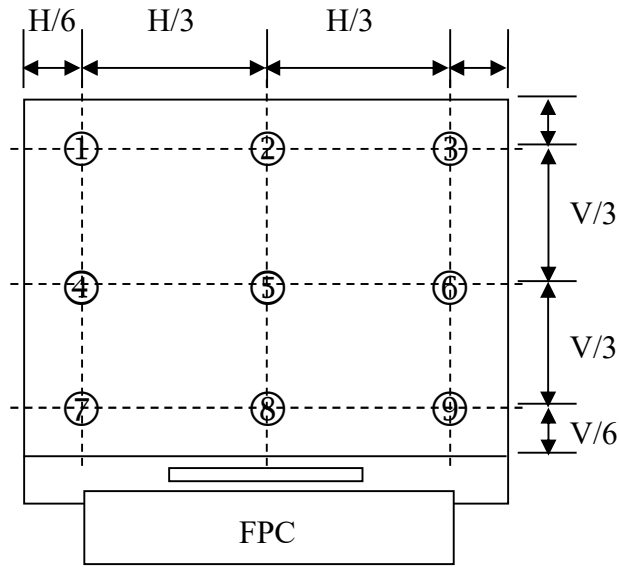
Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio (Center point)		C/R	-	720	900	-	-	Note(1)
Luminance uniformity		U _w	θ = 0. Normal viewing angle B/L On Note(1)	80	85	-	%	Note(2)
Response Time		Tr		-	16	21	ms	Note(3)
		+Tf			19	24		
Color Chromaticity (CIE 1931)		White		W _x		0.310		Note(5)
				W _y		0.336		
		Red	R _x		0.647			
			R _y		0.317			
		Green	G _x	-0.02	0.275	+0.02		
			G _y		0.582			
		Blue	B _x		0.140			
			B _y		0.088			
Viewing Angle		Hor.	∅ 3R		80	-	Deg	Note(4)
			∅ 9L		80	-		
		Ver.	∅ 12U		80	-		
			∅ 6D	-	80	-		



Note1 Definition of Contrast Ratio (CR):

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note2: Definition of Luminance Uniformity: Active area is divided into 9 measuring areas (Shown in below), every measuring point is placed at the center of each measuring area.



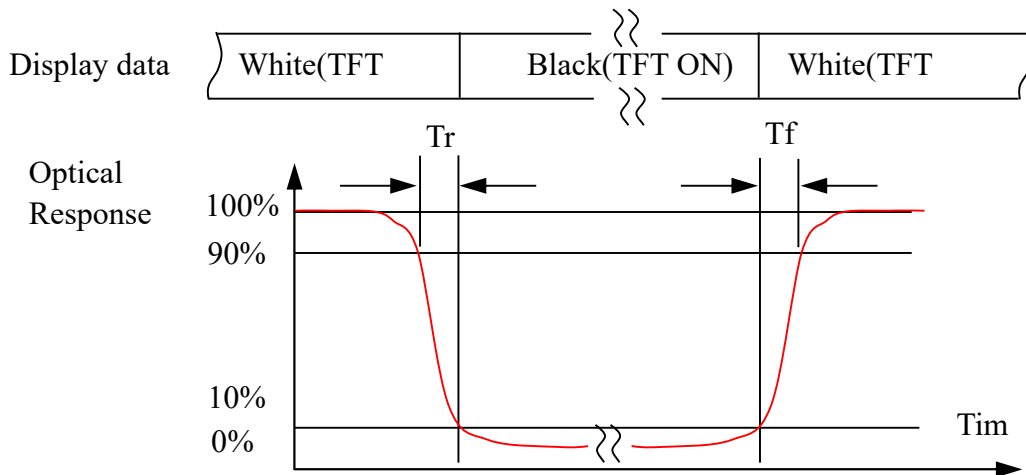
The spot locations for luminance measurement

$$\text{Luminance Uniformity} = \frac{B_{\min}}{B_{\max}} \times 100\%$$

B_{\max} : The measured maximum luminance of all measurement position.

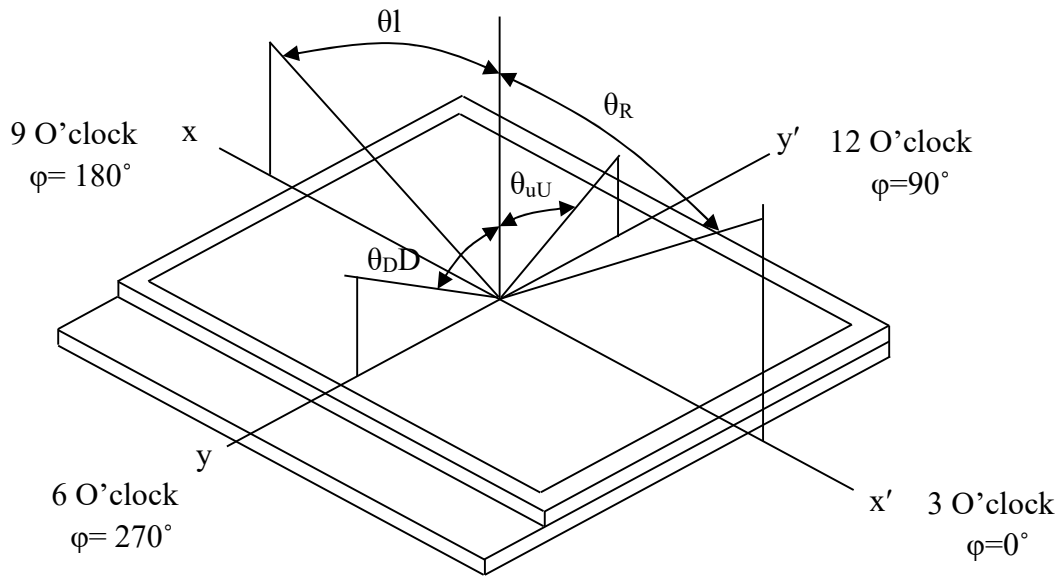
B_{\min} : The measured minimum luminance of all measurement position.

Note 3: Definition of Response time: Sum of T_r and T_f





Note4.Definition of Viewing Angle: The viewing angle range that the CR \geq 10



Note 5: Definition of Color Chromaticity (CIE 1931)

Color coordinate of white & red, green, blue at center point.



6. RELIABILITY TEST CONDITIONS

No	Test Item	Test Condition	STANDARD
1	High Temperature Storage	+80°C / 96Hours	1. Functional test is OK. Missing Segment, short, unclear segment, on-display, display abnormally and liquid crystal leak are un-allowed. 2. No low temperature bubbles, end seal loose and fall, frame rainbow.
2	Low Temperature Storage	-30°C / 96Hours	
3	High Temperature Operating	+70°C / 96Hours	
4	Low Temperature Operating	-20°C / 96Hours	
5	Thermal and cold shock	0°C↔+50°C x 10cycles (30min) (5min) (30min)	
6	Operate at High Temperature and Humidity	60°C x 90%RH / 24H	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude:1.5mm, 2 hours for each direction of X, Y, Z	1. Function test is OK. 2. No glass crack, chipped glass, end seal loose and fall, epoxy frame crack and so on. 3. No structure loose and fall.
8	Dropping test	Drop to the ground from 1m height, 1 corner, 3 edges, 6 surfaces.	
9	ESD test	Contact: ±6KV Air: ±10KV 150PF/330Ω,5Points/panel,5times	The test results shall be subject to the whole machine test.

NOTE:

1. The reliability items will be fully performed in new sample qualification,
2. The reliability status will be tested as monitor during mass production. Individual reliability test shall be performed by lot, Moreover, the individual reliability item shall be decided according to reliability plan.
3. All samples are inspected after keeping in the room with normal temperature and humidity for 2 hours or above.
4. Vibration test: It is not necessary to test for those products without assembly frame, backlight, PCB and so on.
5. Dropping test: It is necessary for affirming new package.
6. For the high temperature and high humidity test, pure water of over 10 MΩ.cm should be used.
7. Each test item applies for test LCM only once. Then tested LCM cannot be used again in any other test item.
8. The quantity of LCM examination for each test item is 5pcs to 10pcs.



7. INSPECTION STANDARDS

8.1 AQL Sampling inspection standard

使用 GB/T 2828-2003 一般 II 水平, 采用正常检查一次抽样方式; 具体抽检方式参照《成品检验管理程序》、《抽样管理规范》

缺陷区分	AQL 允收水准
严重缺陷	0 收 1 退
重缺	0.4
轻缺	1.0

8.2 Inspect the condition

8.2.1 在 20—40W 日光灯的照明条件下, 样品离检查者眼睛约 30cm 处进行检查。检验方向以垂直线前后左右 45° (以时钟 3 点、6 点、9 点、12 点)

8.2.2 检验者视力需达到标准视力 1.0 以上。

8.2.3 检验者需戴静电手环、两手八个手指套。

8.2.4 外观检验者以目视检查或以菲林对比卡比对。

8.2.5 电性测试使用电测测架, 主板, 电源线及单片机。

8.2.6 若标准与规格书不符时, 以产品发行之规格书特殊检验规格、工程变更为准

8.2.7 辉色度检测请参照样品, 检测方法依照辉色度检验标准。

8.2.8 电测检验环境: 照度为 200LUX 以下, 外观检验环境: 照度为 600LUX-1000LUX, 检验时间: 1 秒-3 秒。

8.2.9 检验工具: 电测测架, 主板, 电源线及单片机, 菲林对比卡, 游标卡尺, 放大镜, 实体显微镜 (必要时) 等等。

8.3 Judgment criterion

小尺寸点、线判定标准: (6.2 寸以内)

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定 (A /B/C 区)	$D \leq 0.10$, 忽略不计, 但密集型不允许	MI	OK
				$0.1 < D \leq 0.15$, $ds \geq 10$		$N \leq 2$
				$0.15 < D \leq 0.2$, $ds \geq 10$		$N \leq 1$
				LCD 亮点: $0.15 < D$		$N \leq 1$
				$D > 0.2$		NG
			判定 (D 区)	同背面丝印油墨区杂质判定标准		
			注: 1) D 区的点状缺陷需在不影响 CTP 功能、客户组装及整机的外观的情况下, 判定 OK		MI	
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定 (A /B/C 区)	$W \leq 0.03mm$, $L \leq 3mm$, $ds \geq 10$	MI	$N \leq 2$
				$0.03mm < W \leq 0.05mm$, $L \leq 3mm$, $ds \geq 10$		$N \leq 1$
				$W > 0.05mm$ 或 $L > 3mm$		NG



中尺寸点、线判定标准：(6.2~8寸以内)

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定(A/B/C区)	$D \leq 0.10$, 忽略不计, 但密集型不允许	MI	OK
				$0.15 < D \leq 0.25$, $ds \geq 10$		$N \leq 2$
				$0.25 < D \leq 3$, $ds \geq 10$		$N \leq 1$
				LCD亮点: $0.2 < D$		$N \leq 1$
				$D > 0.3$		NG
判定(D区)	同背面丝印油墨区杂质判定标准					
注: 1) D区的点状缺陷需在不影响CTP功能、客户组装及整机的外观的情况下, 判定OK					MI	
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定(A/B/C区)	$W \leq 0.03mm$, $L \leq 3mm$, $ds \geq 10$	MI	$N \leq 2$
				$0.03mm < W \leq 0.05mm$, $L \leq 3mm$, $ds \geq 10$		$N \leq 1$
				$W > 0.05mm$ 或 $L > 3mm$		NG

大尺寸点、线判定标准：(8.1~13.3寸以内)

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定(A/B/C区)	$D \leq 0.1$, 忽略不计, 但密集型不允许	MI	OK
				$0.15 < D \leq 0.3$, $ds \geq 10$		$N \leq 2$
				$0.3 < D \leq 0.35$, $ds \geq 10$		$N \leq 1$
				LCD亮点: $0.25 < D$		$N \leq 1$
				$D > 0.35$		NG
判定(D区)	同背面丝印油墨区杂质判定标准					
注: 1) D区的点状缺陷需在不影响CTP功能、客户组装及整机的外观的情况下, 判定OK					MI	
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定(A/B/C区)	$W \leq 0.05mm$, $L \leq 5mm$, $ds \geq 10$	MI	$N \leq 2$
				$0.05mm < W \leq 0.07mm$, $L \leq 5mm$, $ds \geq 10$		$N \leq 1$
				$W > 0.07mm$ 或 $L > 5mm$		NG



8. PACKAGE DRAWING

